


Standardized Information Note (IN)

1. Information Note basic data	
1.1 Company	 TAIWAN SEMICONDUCTOR
1.2 Information Note No.	IN16005
1.3 Title of IN	Datasheet correction for BZX585B2V4 - BZX585B51 Series suggested Pad Layout dimensions.No product change.
1.4 Issue date	2016/08/18


2. Contact		
2.1 Contact supplier		
2.1.1 Name	Sunnie Pan	
2.1.2 Phone	886-2-8913-1588 Ext.2205	
2.1.3 Email	sunnie@mail.ts.com.tw	
2.2 Team supplier (optional)		
2.2.1 Name (optional)	2.2.2 Phone (optional)	2.2.3 Email (optional)
Celia Huang	886-2-8913-1588 Ext.2125	celia@mail.ts.com.tw
Hank Hsiao	886-2-8913-1588 Ext.2126	Hank_hsiao@mail.ts.com.tw

3. Description		
	Old	New
Description #1	Pad Layout X1=2.0mm,Y=0.7mm	Pad Layout X1=2.3mm,Y=0.8mm
Description #2		
Description #3		
Description #4		
Description #5		

4. Reason / motivation	
4.1 Motivation	SOD-523F Pad layout integration
4.2 Additional explanation (optional)	

5. Marking of parts / traceability	
5.1 Description	

6. Timing / schedule		
6.1 Intended start of delivery	2016/8/18	

7. Attachments (e.g. additional documentation, pictures, part list....)	
See attached, Involved PN list.xls	
 C:\Documents and Settings\sunnie\桌面\ECN-2016-7-	

8. Affected parts									
8.1 Current						8.2 New (if applicable)			
8.1.1 Customer Part No.	8.1.2 Supplier Part Name	8.1.3 Supplier Part No. (optional)	8.1.4 Package Name	8.1.5 Part Description (optional)	8.1.6 Additional Part Information (optional)	8.2.2 Supplier Part Name	8.2.3 Supplier Part No. (optional)	8.2.4 Package Name	8.2.6 Additional Part Information (optional)

[illegible]